

8Gb (x16 x 2 channel) Mobile LPDDR4/LPDDR4X with ECC

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FEATURES

- · Configuration:
 - 256Mb x16 x 2 channels
 - 8 internal banks per each channel
- On-Chip ECC:
 - Single-bit error correction (per 64-bits)
- · Low-voltage Core and I/O Power Supplies

VDD1 = 1.70-1.95V

VDD2 = 1.06-1.17V

VDDQ = 1.06-1.17V (LPDDR4)

VDDQ = 0.57-0.65V (LPDDR4X)

- LVSTL(Low Voltage Swing Terminated Logic) I/O Interface
- Internal VREF and VREF Training
- · Dynamic ODT:

DQ ODT: VSSQ Termination

CA ODT: VSS Termination

- Max. Clock Frequency : 1.6GHz (3.2Gbps)
- · 16n Pre-fetch DDR architecture
- Single data rate (multiple cycles) command/ address bus
- Bidirectional/differential data strobe per byte of data (DQS/DQS#)
- Programmable burst lengths (16 or 32)
- ZQ Calibration
- Operation Temperature

Industrial $(T_c = -40^{\circ}C \text{ to } 95^{\circ}C)$

Automotive, A1 ($T_C = -40^{\circ}C$ to 95°C)

Automotive, A2 ($T_C = -40^{\circ}C$ to $105^{\circ}C$)

Automotive, A3 (Tc = -40°C to 125°C)

Clock-Stop capability

DESCRIPTION

The IS43/46LQ32256EA and IS43/46LQ32256EAL are 8Gbit CMOS LPDDR4 SDRAM. The device is organized as 2 channels per device, and individual channel is 8-banks and 16-bits. This product uses a double-data-rate architecture to achieve high-speed operation. The double data rate architecture is essentially a 16N prefetch architecture with an interface designed to transfer two data words per clock cycle at the I/O pins. This product offers fully synchronous operations referenced to both rising and falling edges of the clock. The data paths are internally pipelined and 16n bits prefetched to achieve very high bandwidth.

- On-chip temperature sensor whose status can be read from MR4
- 200-ball x32 BGA Package (10x14.5 mm)

ADDRESS TABLE

Parameter	
# of Channel	2
Row Addresses	R0-R14
Column Addresses	C0-C9
Bank Addresses	BA0-BA2

Note: Address information is per channel base.

KEY TIMING PARAMETERS

Speed	Speed Freg.		peed Freq. Data		Write Latency		Read Latency	
Grade	(MHz)	Rate (Mb/s)	Set	Set	DBI	DBI		
	(2,0)	Α	В	OFF	ON			
-062	1600	3200	14	26	28	32		
-075	1333	2666	12	22	24	28		

Note: Other clock frequencies/data rates supported; please refer to AC timing tables.

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a.) the risk of injury or damage has been minimized;

b.) the user assume all such risks; and

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1. BALL ASSIGNMENTS AND DESCRIPTIONS

200-ball x32 Discrete Package, 0.80mm x 0.65mm using MO-311

	_	1	2	3	4	5	6 7	8	9	10	11	12
	A	DNU	DNU	vss	VDD2	ZQ0	0.80mm Pitch	NC	VDD2	vss	DNU/ ERR_A	DNU
	В	DNU	DQ0_A	VDDQ	DQ7_A	VDDQ		VDDQ	DQ15_A	VDDQ	DQ8_A	DNU
	С	vss	DQ1_A	DMI0_A	DQ6_A	vss		vss	DQ14_A	DMI1_A	DQ9_A	vss
	D	VDDQ	vss	DQS0_T_A	vss	VDDQ		VDDQ	vss	DQS1_T_A	vss	VDDQ
	E	vss	DQ2_A	DQS0_C_ A	DQ5_A	vss		vss	DQ13_A	DQS1_C_ A	DQ10_A	vss
	F	VDD1	DQ3_A	VDDQ	DQ4_A	VDD2		VDD2	DQ12_A	VDDQ	DQ11_A	VDD1
	G	vss	ODT_CA_ A (3)	vss	VDD1	vss		vss	VDD1	vss	NC	vss
	н	VDD2	CA0_A	NC	CS0_A	VDD2		VDD2	CA2_A	CA3_A	CA4_A	VDD2
	J	vss	CA1_A	vss	CKE0_A	NC		CK_t_A	CK_c_A	vss	CA5_A	vss
itch	ĸ	VDD2	vss	VDD2	vss	NC		NC	vss	VDD2	vss	VDD2
Ε	L M											
0.65	N	VDD2	vss	VDD2	vss	NC		NC	vss	VDD2	vss	VDD2
	Р	vss	CA1_B	vss	CKE0_B	NC		CK_T_B	CK_C_B	vss	CA5_B	vss
	R	VDD2	CA0_B	NC	CS0_B	VDD2		VDD2	CA2_B	CA3_B	CA4_B	VDD2
	т	vss	ODT_CA_ B (3)	vss	VDD1	vss		vss	VDD1	vss	RESET_N	vss
	U	VDD1	DQ3_B	VDDQ	DQ4_B	VDD2		VDD2	DQ12_B	VDDQ	DQ11_B	VDD1
,	v	vss	DQ2_B	DQS0_C_ B	DQ5_B	vss		vss	DQ13_B	DQS1_C_ B	DQ10_B	vss
,	w	VDDQ	vss	DQS0_T_B	vss	VDDQ		VDDQ	vss	DQS1_T_B	vss	VDDQ
	Y	vss	DQ1_B	DMI0_B	DQ6_B	vss		vss	DQ14_B	DMI1_B	DQ9_B	vss
A	\A	DNU	DQ0_B	VDDQ	DQ7_B	VDDQ		VDDQ	DQ15_B	VDDQ	DQ8_B	DNU
A	ΑВ	DNU	DNU	vss	VDD2	vss		vss	VDD2	vss	DNU/ ERR_B	DNU

NOTE 1 0.8mm pitch (X-axis), 0.65mm pitch (Y-axis), 22 rows.

NOTE 2 Top View, A1 in top left corner.

NOTE 3 The ODT_CA pin is ignored by LPDDR4X devices.

NOTE 4 A11 will be ERR_A. AB11 will be ERR_B in optional B2 package.



2. INPUT/OUTPUT FUNTIONAL DESCRIPTION

2.1 PAD DEFINITION AND DESCRIPTION

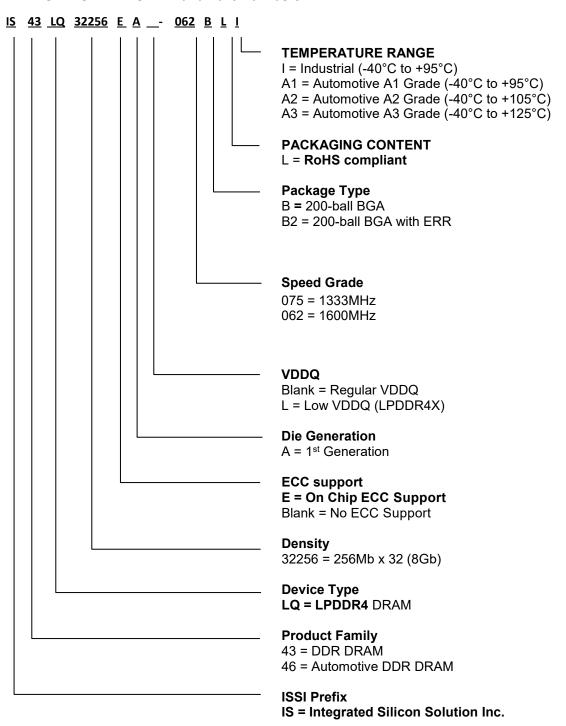
Table 2.1 — Pad Definition and Description

Symbol	Type	Description	
CK_t_A, CK_c_A, CK_t_B, CK_c_B	Input	Clock: CK_t and CK_c are differential clock inputs. All address, command, and control input signals are sampled on the crossing of the positive edge of CK_t and the negative edge of CK_c. AC timings for CA parameters are referenced to CK. Each channel (A & B) has its own clock pair.	
CKE_A CKE_B	Input	Clock Enable: CKE HIGH activates and CKE LOW deactivates the internal clock circuits, input buffers, and output drivers. Power-saving modes are entered and exited via CKE transitions. CKE is part of the command code. Each channel (A & B) has its own CKE signal.	
CS_A CS_B	Input	Chip Select: CS is part of the command code. Each channel (A & B) has its own CS signal.	
CA[5:0]_A CA[5:0]_B	Input	Command/Address Inputs: CA signals provide the Command and Address inputs according to Table 63 — Command Truth Table. Each channel (A&B) has its own CA signals.	
ODT_CA_A ODT_CA_B	Input	LPDDR4 CA ODT Control: The ODT_CA pin is used in conjunction with the Mode Register to turn on/off the On-Die-Termination for CA pins. LPDDR4X CA ODT Control: The ODT_CA pin is ignored by LPDDR4X devices. CA ODT is fully controlled through MR11 and MR22. The ODT_CA pin shall be connected to either VDD2 or VSS.	
DQ[15:0]_A, DQ[15:0]_B	I/O	Data Input/Output: Bi-direction data bus.	
DQS[1:0]_t_A, DQS[1:0]_c_A, DQS[1:0]_t_B, DQS[1:0]_c_B	I/O	Data Strobe: DQS_t and DQS_c are bi-directional differential output clock signals used to strobe data during a READ or WRITE. The Data Strobe is generated by the DRAM for a READ and is edge-aligned with Data. The Data Strobe is generated by the Memory Controller for a WRITE and must arrive prior to Data. Each byte of data has a Data Strobe signal pair. Each channel (A & B) has its own DQS strobes.	
DMI[1:0]_A, DMI[1:0]_B	I/O	Data Mask Inversion: DMI is a bi-directional signal which is driven HIGH when the data on the data bus is inverted, or driven LOW when the data is in its normal state. Data Inversion can be disabled via a mode register setting. Each byte of data has a DMI signal. Each channel (A & B) has its own DMI signals.	
ZQ	Reference	Calibration Reference: Used to calibrate the output drive strength and the termination resistance. There is one ZQ pin per die. The ZQ pin shall be connected to $V_{DD}Q$ through a 240 Ω ± 1% resistor.	
V _{DD} Q, V _{DD} 1, V _{DD} 2	Supply	Power Supplies: Isolated on the die for improved noise immunity.	
V _{SS} , V _{SS} Q	GND	Ground Reference: Power supply ground reference	
RESET_n	Input	RESET: When asserted LOW, the RESET_n signal resets both channels of the die.	

Note 1 Optional ERR_A, ERR_B in optional B2 package will be described in section 11



ORDERING INFORMATION – Valid Part Numbers





ORDERING INFORMATION, 256Mb x 32 LPDDR4

Industrial Range: Tc = -40°C to +95°C

Clock	Speed Grade	Order Part No.	Package
4222 MILE	-075	IS43LQ32256EA-075BLI	200 ball FBGA, lead free
1333 MHz	-075	IS43LQ32256EA-075B2LI	200 ball FBGA, lead free, ERR
1600 MHz	z -062	IS43LQ32256EA-062BLI	200 ball FBGA, lead free
		IS43LQ32256EA-062B2LI	200 ball FBGA, lead free, ERR

Automotive, A1 Range: Tc = -40°C to +95°C

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS46LQ32256EA-075BLA1	200 ball FBGA, lead free
	-0/5	IS46LQ32256EA-075B2LA1	200 ball FBGA, lead free, ERR
1600 MHz	-062	IS46LQ32256EA-062BLA1	200 ball FBGA, lead free
		IS46LQ32256EA-062B2LA1	200 ball FBGA, lead free, ERR

Automotive, A2 Range: Tc = -40°C to +105°C

Clock	Speed Grade	Order Part No.	Package
4222 MILE	-075	IS46LQ32256EA-075BLA2	200 ball FBGA, lead free
1333 MHz	-075	IS46LQ32256EA-075B2LA2	200 ball FBGA, lead free, ERR
1600 MHz	-062	IS46LQ32256EA-062BLA2	200 ball FBGA, lead free
		IS46LQ32256EA-062B2LA2	200 ball FBGA, lead free, ERR

Automotive, A25 Range: Tc = -40°C to +115°C

Clock	Speed Grade	Order Part No.	Package
1600 MHz	063	IS46LQ32256EA-062BLA25	200 ball FBGA, lead free
	00 MHz -062	IS46LQ32256EA-062B2LA25	200 ball FBGA, lead free, ERR

Automotive, A3 Range: Tc = -40°C to +125°C

Clock	Speed Grade	Order Part No.	Package
1222 MU=	075	IS46LQ32256EA-075BLA3	200 ball FBGA, lead free
1333 MHz	-075	IS46LQ32256EA-075B2LA3	200 ball FBGA, lead free, ERR
1600 MHz	z -062	IS46LQ32256EA-062BLA3	200 ball FBGA, lead free
		IS46LQ32256EA-062B2LA3	200 ball FBGA, lead free, ERR



ORDERING INFORMATION, 256Mb x 32 LPDDR4X

Industrial Range: Tc = -40°C to +95°C

Clock	Speed Grade	Order Part No.	Package
4000 MILE	33 MHz -075	IS43LQ32256EAL-075BLI	200 ball FBGA, lead free
1333 1/11/2		IS43LQ32256EAL-075B2LI	200 ball FBGA, lead free, ERR
1600 MHz	-062	IS43LQ32256EAL-062BLI	200 ball FBGA, lead free
		IS43LQ32256EAL-062B2LI	200 ball FBGA, lead free, ERR

Automotive, A1 Range: Tc = -40°C to +95°C

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS46LQ32256EAL-075BLA1	200 ball FBGA, lead free
	-0/5	IS46LQ32256EAL-075B2LA1	200 ball FBGA, lead free, ERR
1600 MHz	-062	IS46LQ32256EAL-062BLA1	200 ball FBGA, lead free
		IS46LQ32256EAL-062B2LA1	200 ball FBGA, lead free, ERR

Automotive, A2 Range: Tc = -40°C to +105°C

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS46LQ32256EAL-075BLA2	200 ball FBGA, lead free
	-075	IS46LQ32256EAL-075B2LA2	200 ball FBGA, lead free, ERR
1600 MHz	-062	IS46LQ32256EAL-062BLA2	200 ball FBGA, lead free
		IS46LQ32256EAL-062B2LA2	200 ball FBGA, lead free, ERR

Automotive, A3 Range: Tc = -40°C to +125°C

Clock	Speed Grade	Order Part No.	Package
1333 MHz	-075	IS46LQ32256EAL-075BLA3	200 ball FBGA, lead free
		IS46LQ32256EAL-075B2LA3	200 ball FBGA, lead free, ERR
1600 MHz	-062	IS46LQ32256EAL-062BLA3	200 ball FBGA, lead free
		IS46LQ32256EAL-062B2LA3	200 ball FBGA, lead free, ERR



PACKAGE INFORMATION: 200-ball FBGA

